6-6-03 To the Honorable Commissioner of Patents and Trademark	June 5, 2003
Disease record the attached original documents or convitere.	102472347 .orney Docket No. 5649-1096
Please record the attached original documents or copy thereo.	
1. Name of conveying party(ies): Chang-Hyun Lee Dong-Gun Park	2. Name and address of receiving party(ies): Samsung Electronics Co., Ltd. 416 Maetan-dong, Paldal-gu Suwon-city, Kyungki-do Republic of Korea
Additional name(s) of conveying party(ies) attached? Yes X No	
3. Nature of conveyance:	
X Assignment Merger Security Agreement Change of Name Other Execution Date: <u>May 16, 2003</u>	
	Additional name(s) & address(es) attached? Yes X No
 4. Application Serial No. <u>19</u>, <u>455679</u> Patent N If this document is being filed together with a new application is: <u>June 5, 2003</u> Additional numbers attached? <u>Yes X No</u> 	
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: 1
concerning document should be mailed: Customer Number 20792 Elizabeth A. Stanek Myers Bigel Sibley & Sajovec Post Office Box 37428 Raleigh, North Carolina 27627	 7. Total fee (37 CFR 3.41) <u>\$40.00</u> <u>X</u> Enclosed Authorized to be charged to deposit account 8. Deposit account number: 50-0220
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of the original document.	r_{mation} is true and correct and any attached copy is a true copy
Elizabeth A. Stanek, Reg. 48,568 Name of Person Signing Signature Tota	<u>June 5, 2003</u> Date al number of pages including cover sheet, attachments and document:
6/09/2003 SSITHIB1 00000065 10455679	
4 FC:8021 40.00 00	

PATENT REEL: 014152 FRAME: 0467

ASSIGNMENT

THIS ASSIGNMENT, made by me, **Chang-Hyun Lee**; citizen of the Republic of Korea, residing at 202, 1039-12 Ycongtong-dong, Paldal-gu, Suwon-si, Gyeonggi-do, Republic of Korea; and **Dong-Gun Park**, citizen of the Republic of Korea, residing at 801-401, Jeil APT., Mujigae Maeul Gumi-dong, Bundang-gu, Sungnam-si, Gyeonggi-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, I am the sole inventor of certain new and useful improvements in Flash Memory Devices Having Self Aligned Shallow Trench Isolation Structures And Methods Of Fabricating The Same for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. I hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. ______ filed ______) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made.

I hereby request that said Letters Patent be issued in accordance with this assignment. I further covenant and agree that, at the time of the execution and delivery of these presents, I possess full title to the invention and application above-mentioned, and that I have the unencumbered right and authority to make this assignment.

PATENT REEL: 014152 FRAME: 0468

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I further covenant and agree to bind my heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to me relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignce complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 16 day of of , 2003.

Chang-Hyunder (SEAL) Chang-Hyun Lee May. '6. 2003 Deng Gun Park (SEAL) Dong-Gun Park May 16, 2003

Witnessed by:

Date:

Date:

5649-1096